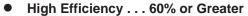
TL497A 500-mA PEAK STEP-UP, STEP-DOWN, INVERTING SWITCHING VOLTAGE REGULATOR

SLVS009F - JUNE 1976 - REVISED FEBRUARY 2005



- Peak Switch Current . . . 500 mA
- Input Current Limit Protection
- TTL-Compatible Inhibit
- Adjustable Output Voltage
- Input Regulation . . . 0.2% Typ
- Output Regulation . . . 0.4% Typ
- Soft Start-Up Capability
- Can be Used in Buck, Boost, and Inverting Configurations

COMP INPUT [1 14] V_{CC} INHIBIT [2 13] CUR LIM SENS FREQ CONTROL [3 12] BASE DRIVE† SUBSTRATE [4 11] BASE† GND [5 10] COL OUT CATHODE [6 9] NC ANODE [7 8] EMIT OUT

D, N, OR PW PACKAGE

NC - No internal connection

description/ordering information

The TL497A incorporates all the active functions required in the construction of switching voltage regulators. It also can be used as the control element to drive external components for high-power-output applications. The TL497A was designed for ease of use in step-up, step-down, or voltage-inversion applications requiring high efficiency.

The TL497A is a fixed-on-time variable-frequency switching-voltage-regulator control circuit. The switch-on time is programmed by a single external capacitor connected between FREQ CONTROL and GND. This capacitor, C_T , is charged by an internal constant-current generator to a predetermined threshold. The charging current and the threshold vary proportionally with V_{CC} . Thus, the switch-on time remains constant over the specified range of input voltage (4.5 V to 12 V). Typical on times for various values of C_T are as follows:

TIMING CAPACITOR, C _T (pF)	200	250	350	400	500	750	1000	1500	2000
ON TIME (μs)	19	22	26	32	44	56	80	120	180

The output voltage is controlled by an external resistor ladder network (R1 and R2 in Figures 1, 2, and 3) that provides a feedback voltage to the comparator input. This feedback voltage is compared to the reference voltage of 1.2 V (relative to SUBSTRATE) by the high-gain comparator. When the output voltage decays below the value required to maintain 1.2 V at the comparator input, the comparator enables the oscillator circuit, which charges and discharges C_T as described above. The internal pass transistor is driven on during the charging of C_T . The internal transistor can be used directly for switching currents up to 500 mA. Its collector and emitter are uncommitted, and it is current driven to allow operation from the positive supply voltage or ground. An internal Schottky diode matched to the current characteristics of the internal transistor also is available for blocking or commutating purposes. The TL497A also has on-chip current-limit circuitry that senses the peak currents in the switching regulator and protects the inductor against saturation and the pass transistor against overstress. The current limit is adjustable and is programmed by a single sense resistor, R_{CL} , connected between V_{CC} and CUR LIM SENS. The current-limit circuitry is activated when 0.7 V is developed across R_{CL} . External gating is provided by the INHIBIT input. When the INHIBIT input is high, the output is turned off.

Simplicity of design is a primary feature of the TL497A. With only six external components (three resistors, two capacitors, and one inductor), the TL497A operates in numerous voltage-conversion applications (step-up, step-down, invert) with as much as 85% of the source power delivered to the load. The TL497A replaces the TL497 in all applications.

The TL497AC is characterized for operation from 0° C to 70° C. The TL497AI is characterized for operation from -40° C to 85° C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



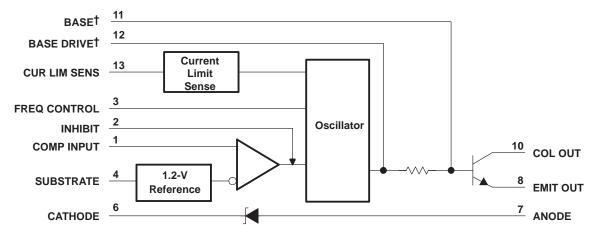
[†]BASE (11) and BASE DRIVE (12) are used for device testing only. They normally are not used in circuit applications of the device.

AVAILABLE OPTIONS

	PA	CKAGED DEVICE	ES	CHIP	
TA	SMALL-OUTLINE PLASTIC (N)		SHRINK SMALL-OUTLINE (PW)	FORM (Y)	
0°C to 70°C	TL497ACD	TL497ACN	TL497ACPW	TL497AY	
-40°C to 85°C	TL497AID	TL497AIN	_	_	

The D and PW packages are only taped and reeled. Add the suffix R to the device type (e.g., TL497ACPWR). Chip forms are tested at 25°C.

functional block diagram



[†]BASE and BASE DRIVE are used for device testing only. They normally are not used in circuit applications of the device.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	15 V
Output voltage, VO	35 V
Input voltage, V _I (COMP INPUT)	5 V
Input voltage, V _I (INHIBIT)	5 V
Diode reverse voltage	35 V
Power switch current	750 mA
Diode forward current	750 mA
Package thermal impedance, θ_{JA} (see Notes 2 and 3): D	package 86°C/W
N	package 101°C/W
P'	W package 113°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 60 se	conds 260°C
Storage temperature range, T _{stq}	–65°C to 150°C

[†]Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except diode voltages, are with respect to network ground terminal.

- 2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
- 3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

			MIN	MAX	UNIT
Supply voltage, V _{CC}	4.5	12	V		
High-level input voltage, VIH	INHIBIT pin		2.5		V
Low-level input voltage, V _{IL}	INHIBIT pin	INHIBIT pin			
	Step-up configuration (see Figure 1)	V _I + 2	30		
Output voltage	Step-down configuration (see Figure 2)	V _{ref}	V _I – 1	V	
	Inverting regulator (see Figure 3)	-V _{ref}	-25		
Power switch current		500	mA		
Diode forward current		500	mA		
Operating free six temperature range T.					°C
Operating free-all temperature rang	Operating free-air temperature range, T _A TL497AI				<u> </u>

TL497A 500-mA PEAK STEP-UP, STEP-DOWN, INVERTING SWITCHING VOLTAGE REGULATOR

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electrical characteristics over recommended operating conditions, $V_{CC} = 6 \text{ V}$ (unless otherwise noted)

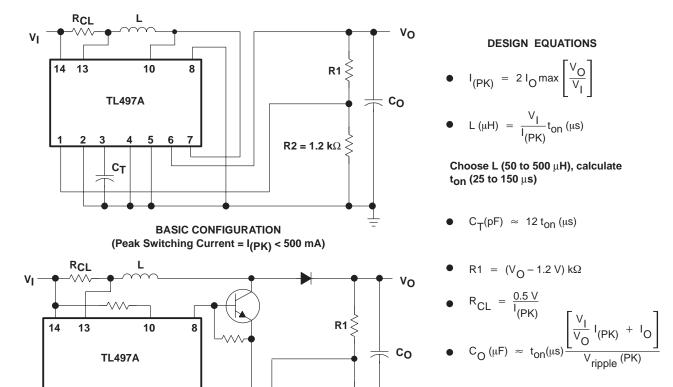
	TEST CONDITIONS		_ +	1	L497AC	;	TL497AI				
PARAMETER	TEST CO	ONDITIONS	T _A †	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
High-level input current, INHIBIT	V _{I(I)} = 5 V		Full range		0.8	1.5		0.8	1.5	mA	
Low-level input current, INHIBIT	V _{I(I)} = 0 V		Full range		5	10		5	20	μΑ	
Comparator reference voltage	V _I = 4.5 V to	6 V	Full range	1.08	1.2	1.32	1.14	1.2	1.26	V	
Comparator input bias current	V _I = 6 V		Full range		40	100		40	100	μΑ	
0 11 11 11		I _O = 100 mA	25°C		0.13	0.2		0.13	0.2		
Switch on-state voltage	V _I = 4.5 V	$I_0 = 500 \text{ mA}$	Full range			0.85			1	V	
			25°C		10	50		10	50	μА	
Switch off-state current	$V_1 = 4.5 V$	VO = 30 V	Full range			200			500		
Sense voltage, CUR LIM SENS	V _I = 6 V		25°C	0.45		1	0.45		1	V	
	I _O = 10 mA I _O = 100 mA I _O = 500 mA		Full range		0.75	0.85		0.75	0.95	V	
Diode forward voltage			Full range		0.9	1		0.9	1.1		
			Full range		1.33	1.55		1.33	1.75		
D'a da manana and ta ma	ΙΟ = 500 μΑ		Full range				30			V	
Diode reverse voltage	$I_{O} = 200 \mu A$	Ι _Ο = 200 μΑ		30							
					11	14		11	14	mA	
On-state supply current			Full range			15		_	16		
0" -1-1			25°C		6	9		6	9		
Off-state supply current			Full range			10			11	mA	

[†]Full range is 0°C to 70°C for the TL497AC and -40°C to 85°C for the TL497AI.

electrical characteristics over recommended operating conditions, V_{CC} = 6 V, T_A = 25°C (unless otherwise noted)

DADAMETED	TEGT CONDITIONS	TL497AY	UNIT	
PARAMETER	TEST CONDITIONS	MIN TYP MAX		
High-level input current, INHIBIT	V _{I(I)} = 5 V	0.8	mA	
Low-level input current, INHIBIT	V _{I(I)} = 0 V	5	μΑ	
Comparator reference voltage	V _I = 4.5 V to 6 V	1.2	V	
Comparator input bias current	V _I = 6 V	40	μΑ	
Switch on-state voltage	$V_I = 4.5 \text{ V}, \qquad I_O = 100 \text{ mA}$	0.13	V	
Switch off-state current	$V_{I} = 4.5 \text{ V}, \qquad V_{O} = 30 \text{ V}$	10	μΑ	
	I _O = 10 mA	0.75		
Diode forward voltage	I _O = 100 mA	0.9	V	
	I _O = 500 mA	1.33		
On-state supply current		11	mA	
Off-state supply current		6	mA	

[‡] All typical values are at $T_A = 25$ °C.



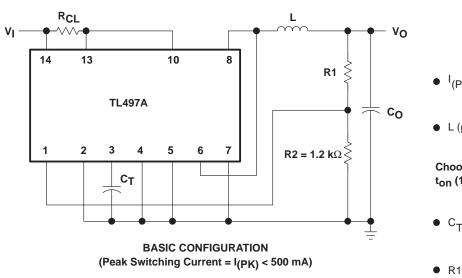
R2 = 1.2 kΩ $\stackrel{>}{\sim}$

EXTENDED POWER CONFIGURATION (using external transistor)

4 5

Ст

Figure 1. Positive Regulator, Step-Up Configurations

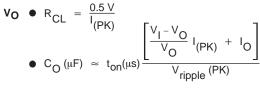


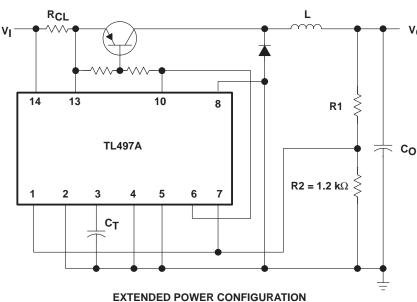
DESIGN EQUATIONS

- \bullet $I_{(PK)} = 2I_{O} \max$
- $\bullet \ \ L \ (\mu H) \ \ = \ \frac{V_I V_O}{I_{(PK)}} t_{ON}(\mu s)$

Choose L (50 to 500 $\mu\text{H}),$ calculate $t_{\mbox{on}}$ (10 to 150 $\mu\text{s})$

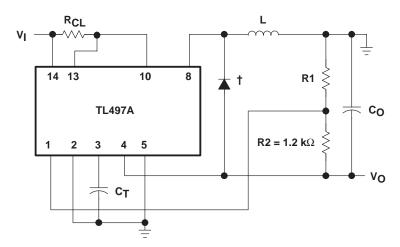
- $C_T(pF) \approx 12 t_{on}(\mu s)$
- R1 = $(V_O 1.2 \text{ V}) \text{ k}\Omega$



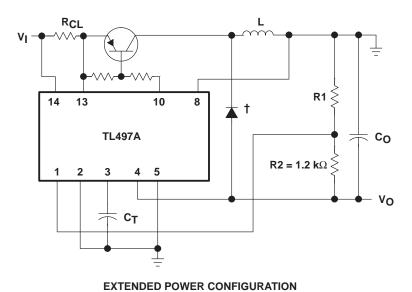


(using external transistor)

Figure 2. Positive Regulator, Step-Down Configurations



BASIC CONFIGURATION
(Peak Switching Current = I_(PK) < 500 mA)



DESIGN EQUATIONS

$$\bullet I_{(PK)} = 2I_{O} \max \left[1 + \frac{|V_{O}|}{V_{I}} \right]$$

•
$$L(\mu H) = \frac{V_I}{I(PK)} t_{ON}(\mu s)$$

Choose L (50 to 500 μ H), calculate t_{on} (10 to 150 μ s)

•
$$C_T(pF) \approx 12 t_{on}(\mu s)$$

• R1 =
$$(|V_{\Omega}| - 1.2 \text{ V}) \text{ k}\Omega$$

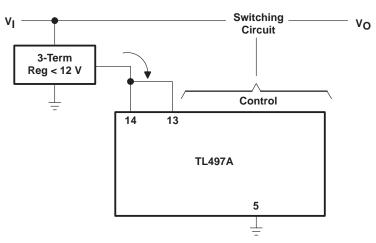
$$R_{CL} = \frac{0.5 \text{ V}}{I(PK)}$$

$$C_{O}(\mu F) \approx t_{ON}(\mu s) \frac{\left[\frac{V_{I}}{|V_{O}|} I_{(PK)} + I_{O}\right]}{V_{ripple}(PK)}$$

(using external transistor)

Figure 3. Inverting Applications

[†]Use external catch diode, e.g., 1N4001, when building an inverting supply with the TL497A.



EXTENDED INPUT CONFIGURATION WITHOUT CURRENT LIMIT

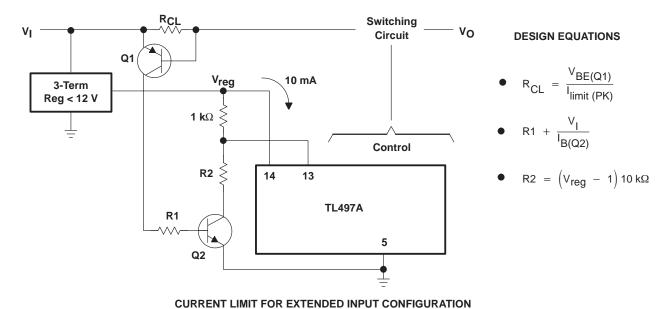


Figure 4. Extended Input Voltage Range (V_I > 12 V)







PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TL497ACD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL497ACNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL497ACNSLE	OBSOLETE	SO	NS	14		TBD	Call TI	Call TI
TL497ACNSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACNSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497ACPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497AID	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497AIDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497AIDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497AIDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL497AIJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
TL497AIN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL497AINE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

18-Nov-2006

package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

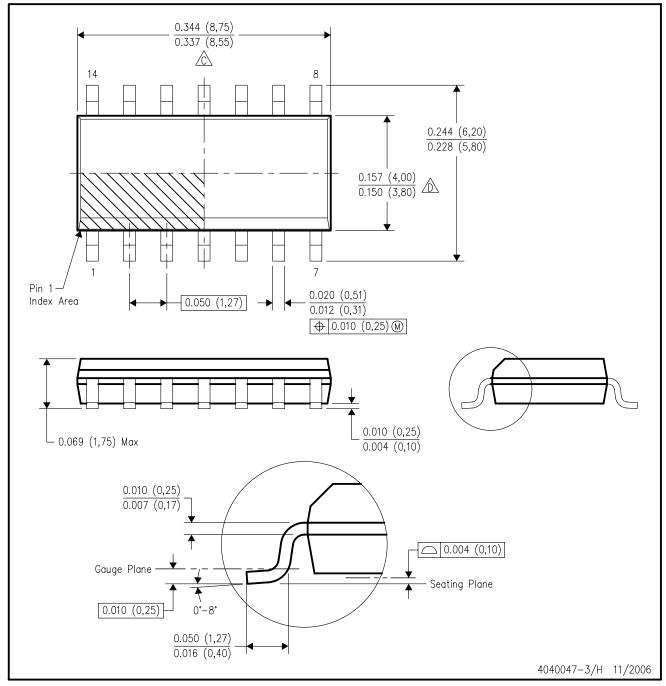


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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